

Resonant Lamp Ballast Controller

FEATURES

- Controls Different Types of Lamps: Cold Cathode Fluorescent, Neon, and Gas Discharge
- Zero Voltage Switching (ZVS) of Push-Pull Drivers
- Accurate Control of Lamp Current
- Variable Lamp Intensity Control
- 1 μ A Disable Current
- 4.5V to 24V Operation
- Open Lamp Detection Circuitry

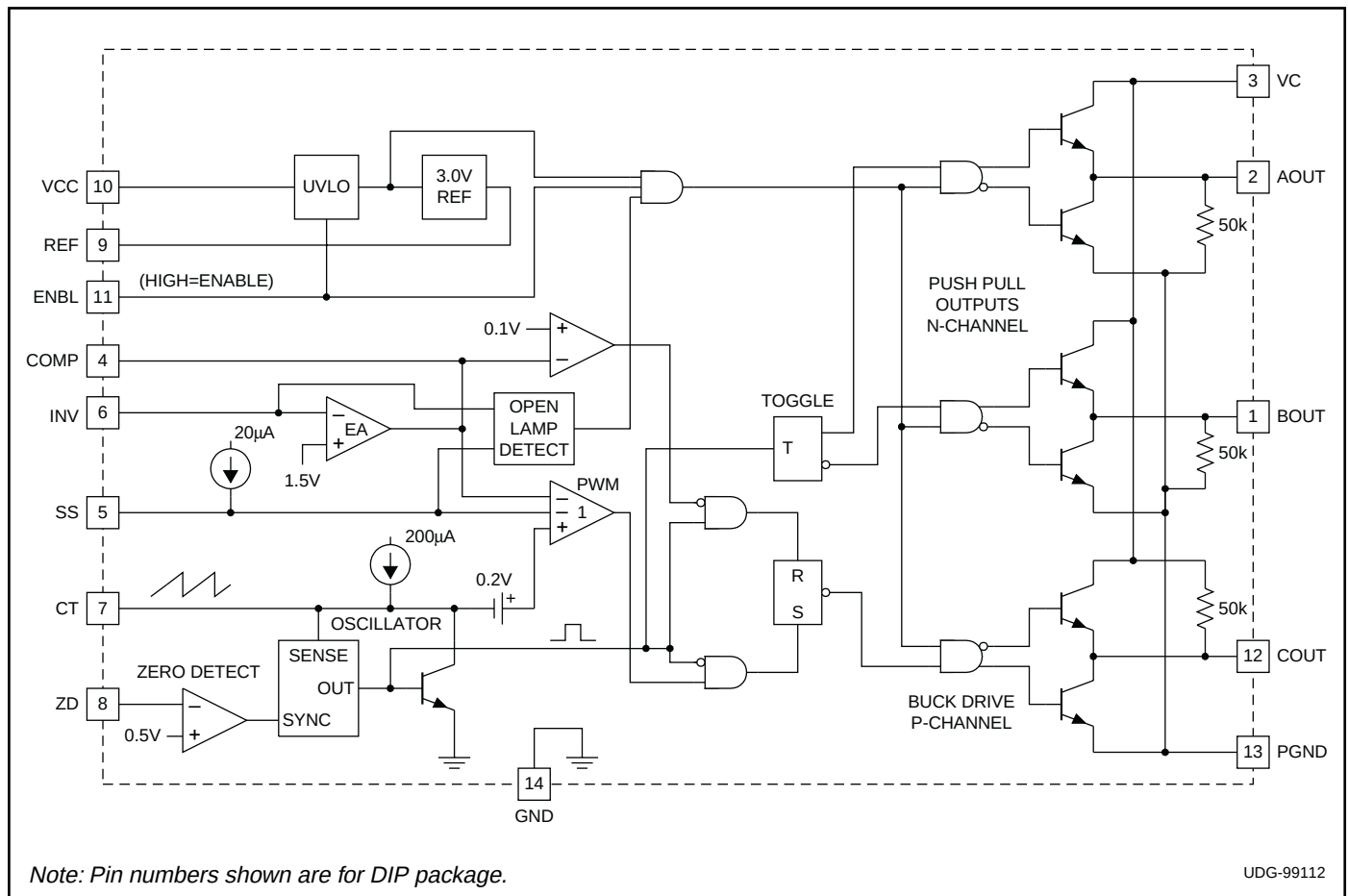
DESCRIPTION

The UC3872 is a resonant lamp ballast controller optimized for driving cold cathode fluorescent, neon, and other gas discharge lamps. The resonant power stage develops a sinusoidal lamp drive voltage, and minimizes switching loss and EMI generation. Lamp intensity adjustment is accomplished with a buck regulator, which is synchronized to the external power stage's resonant frequency. Suitable for automotive and battery powered applications, the UC3872 draws only 1 μ A when disabled.

Soft start and open lamp detect circuitry have been incorporated to minimize component stresses. Open lamp detection is enabled at the completion of a soft start cycle. The chip is optimized for smooth duty cycle control to 100%.

Other features include a precision 1.2% reference, undervoltage lockout, and accurate minimum and maximum frequency control.

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

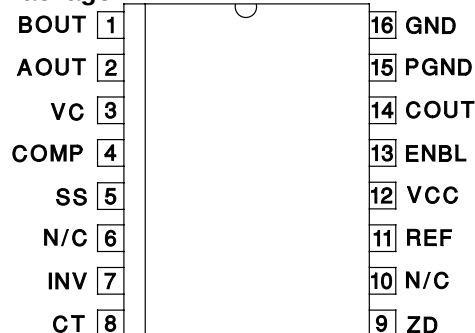
Analog Inputs -0.3 to +10V
VCC, VC Voltage. +24V
ZD Input Current
 High Impedance Source +10mA
ZD Input Voltage
 Low Impedance Source +24V
Power Dissipation at T_A = 25°C 1W
Storage Temperature -65°C to +150°C
Lead Temperature. 300°C

Note 1: Currents are positive into, negative out of the specified terminal.

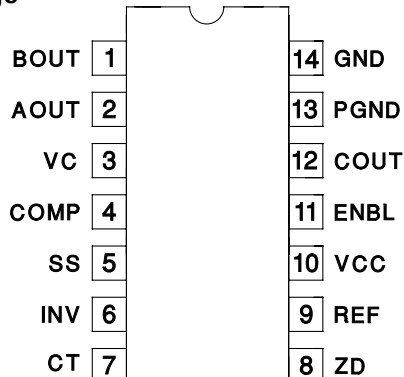
Note 2: Consult Packaging Section of Databook for thermal limitations and considerations of package.

CONNECTION DIAGRAMS

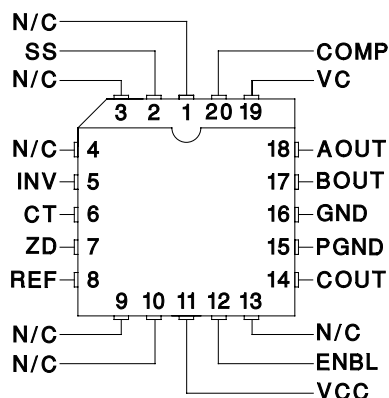
SOIC-16, SSOP-16 (TOP VIEW) DW, M Package



DIL-14 (TOP VIEW) N Package



PLCC-20 (Top View) Q Package



ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these parameters apply for T_J = -55°C to +125°C for the UC1872, -40°C to +85°C for the UC2872, -0°C to +70°C for the UC3872; VCC = 5V, VC = 15V, V_{ENBL} = 5V, CT = 1nF, ZD = 1V.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Reference Section					
Output Voltage	T _J = 25°C	2.963	3.000	3.037	V
	Over Temperature	2.940	3.000	3.060	V
Line Regulation	VCC = 4.75V to 18V			10	mV
Load Regulation	I _O = 0 to -5mA			10	mV
Oscillator Section					
Free Running Frequency	T _J = 25°C	57	68	78	kHz
Maximum Synchronization Frequency	T _J = 25°C	160	200	240	kHz
Charge Current	V _{CT} = 1.5V	180	200	220	μA
Voltage Stability				2	%
Temperature Stability			4	8	%
Zero Detect Threshold		0.46	0.5	0.56	V
Error Amp Section					
Input Voltage	V _O = 2V	1.445	1.475	1.505	V
Input Bias Current			-0.4	-2	μA
Open Loop Gain	V _O = 0.5 to 3V	65	90		dB
Output High	V _{INV} = 1.3V	3.1	3.5	3.9	V

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these parameters apply for $T_J = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ for the UC1872, -40°C to $+85^{\circ}\text{C}$ for the UC2872, -0°C to $+70^{\circ}\text{C}$ for the UC3872; $V_{CC} = 5\text{V}$, $V_C = 15\text{V}$, $V_{ENBL} = 5\text{V}$, $C_T = 1\text{nF}$, $Z_D = 1\text{V}$.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Error Amp Section (cont.)					
Output Low	$V_{INV} = 1.7\text{V}$		0.1	0.2	V
Output Source Current	$V_{INV} = 1.3\text{V}$, $V_O = 2\text{V}$	-350	-500		μA
Output Sink Current	$V_{INV} = 1.7\text{V}$, $V_O = 2\text{V}$	10	20		mA
Common Mode Range		0		$V_{IN}-1\text{V}$	V
Unity Gain Bandwidth	$T_J = 25^{\circ}\text{C}$ (Note 4)		1		MHz
Open Lamp Detect Section					
Soft Start Threshold	$V_{INV} = 0\text{V}$	2.9	3.4	3.8	V
Open Lamp Detect Threshold	$V_{SS} = 4.2\text{V}$	0.6	1.0	1.4	V
Soft Start Current	$V_{SS} = 2\text{V}$	10	20	40	μA
Output Section					
Output Low Level	$I_{OUT} = 0$, Outputs A and B		0.05	0.2	V
	$I_{OUT} = 10\text{mA}$		0.1	0.4	V
	$I_{OUT} = 100\text{mA}$		1.5	2.2	V
Output High Level	$I_{OUT} = 0$, Output C	13.9	14.9		V
	$I_{OUT} = -10\text{mA}$	13.5	14.3		V
	$I_{OUT} = -100\text{mA}$	12.5	13.5		V
Rise Time	$T_J = 25^{\circ}\text{C}$, $C_I = 1\text{nF}$ (Note 4)		30	80	ns
Fall Time	$T_J = 25^{\circ}\text{C}$, $C_I = 1\text{nF}$ (Note 4)		30	80	ns
Output Dynamics					
Out A and B Duty Cycle		48	49.9	50	%
Out C Max Duty Cycle	$V_{INV} = 1\text{V}$	100			%
Out C Min Duty Cycle	$V_{INV} = 2\text{V}$			0	%
Under Voltage Lockout Section					
Startup Threshold Voltage		3.7	4.2	4.5	V
Hysteresis		120	200	280	mV
Enable Section					
Input High Threshold		2			V
Input Low Threshold				0.8	V
Input Current	$V_{ENBL} = 5\text{V}$		150	400	μA
Supply Current Section					
VCC Supply Current	$V_{CC} = 24\text{V}$		6	14	mA
VC Supply Current	$V_C = 24\text{V}$		5	12	mA
ICC Disabled	$V_{CC} = 24\text{V}$, $V_{ENBL} = 0\text{V}$		1	10	μA

Note 3: Unless otherwise specified, all voltages are with respect to ground. Currents are positive into, and negative out of the specified terminal.

Note 4: Guaranteed by design. Not 100% tested in production.

PIN DESCRIPTIONS

AOUT, BOUT: These outputs provide complementary drive signals for the push-pull N-channel MOSFETs. Each one is high for 50% of the time, switching states each time a zero-detect is sensed.

COMP: COMP is the output terminal of the error amplifier. Compensation components are normally connected between COMP and INV. Connecting a capacitor from this pin to ground limits turn on current and blanks the open lamp detect signal allowing the lamp to start.

COUT: This output directly drives the bulk regulator P-channel MOSFET. COUT turn-on is synchronized to each zero-detect, and therefore switches at twice the frequency of AOUT and BOUT. The modulator controlling COUT is designed to provide smooth control up to 100% duty cycle.

CT: A capacitor connected between this pin and GND ground sets the synchronization frequency range. The capacitor is charged with approximately 200 μ A, creating a linear ramp which is used by COUT's (buck regulator driver) PWM comparator.

ENBL: When ENBL is driven high the device is enabled. When ENBL is pulled low, the IC is shut down and typically draws 1 μ A.

GND: This pin is the ground reference point for the internal reference and all thresholds.

INV: This pin is the inverting input to the error amplifier and the input for the open lamp detect circuitry. If the voltage at INV is below the 1V open lamp detect threshold, the outputs are disabled.

PGND: This pin is the high current ground connection for the three output drivers.

REF: This pin is connected to the 3V reference voltage which is used for the internal logic. Bypass REF to ground with a 0.01 μ F ceramic capacitor for proper operation.

VC: VC is the power supply voltage connection for the output drivers. Bypass it to ground with a 0.1 μ F ceramic capacitor for proper operation.

VCC: VCC is the positive supply voltage for the chip. Its operating range is from 4.2V to 24V. Bypass VCC to ground with a 0.1 μ F ceramic capacitor for proper operation.

ZD: The zero-detect input senses when the transformer's primary center tap voltage falls to zero to synchronize the sawtooth voltage waveform on CT. The threshold is approximately 0.5V, providing a small amount of offset such that with propagation delay, zero-volt switching occurs. A resistor (typically 10k) should be connected between ZD and the primary center tap to limit input current at turn off.

APPLICATION INFORMATION

Figure 1 shows a complete application circuit using the UC3872 Resonant Lamp Ballast Controller. The IC provides all drive, control and housekeeping functions. The buck output voltage (transformer center-tap) provides the zero crossing and synchronization signals.

The buck modulator drives a P-channel MOSFET directly, and operates over a 0-100% duty-cycle range. The modulation range includes 100%, allowing operation with minimal headroom.

The oscillator and synchronization circuitry are shown in Figure 2. The oscillator is designed to synchronize over a 3:1 frequency range. In an actual application however, the frequency range is only about 1.5:1. A zero detect comparator senses the primary center-tap voltage, generating a synchronization pulse when the resonant wave-

form falls to zero. The actual threshold is 0.5 volts, providing a small amount of anticipation to offset propagation delay.

The synchronization pulse width is the time required for the 4mA current sink to discharge the timing capacitor to 0.1 volts. This pulse width limits the minimum linear control range of the buck regulator. The 200 μ A current source charges the capacitor to a maximum of 3 volts. A comparator blanks the zero detect signal until the capacitor voltage exceeds 1 volt, preventing multiple synchronization pulse generation and setting the maximum frequency. If the capacitor voltage reaches 3 volts (a zero detection has not occurred) an internal clock pulse is generated to limit the minimum frequency.

APPLICATION INFORMATION (cont.)

A unique protection feature incorporated in the UC3872 is the Open Lamp Detect circuit. An open lamp interrupts the current feedback loop and causes very high secondary voltage. Operation in this mode will usually breakdown the transformer's insulation, causing permanent damage to the converter. The open lamp detect circuit, shown in Figure 3 senses the lamp current feedback signal at the error amplifier's input, and shuts down the outputs if insufficient signal is present. Soft start circuitry limits initial turn-on currents and blanks the open lamp detect signal.

Other features are included to minimize external circuitry requirements. A logic level enable pin shuts down the IC, allowing direct connection to a battery. During shutdown, the IC typically draws less than $1\mu\text{A}$. The UC3872, operating from 4.5V to 24V, is compatible with almost all battery voltages used in portable computers and automotive applications. Undervoltage lockout circuitry disables operation until sufficient supply voltage is available, and a 1% voltage reference insures accurate operation.

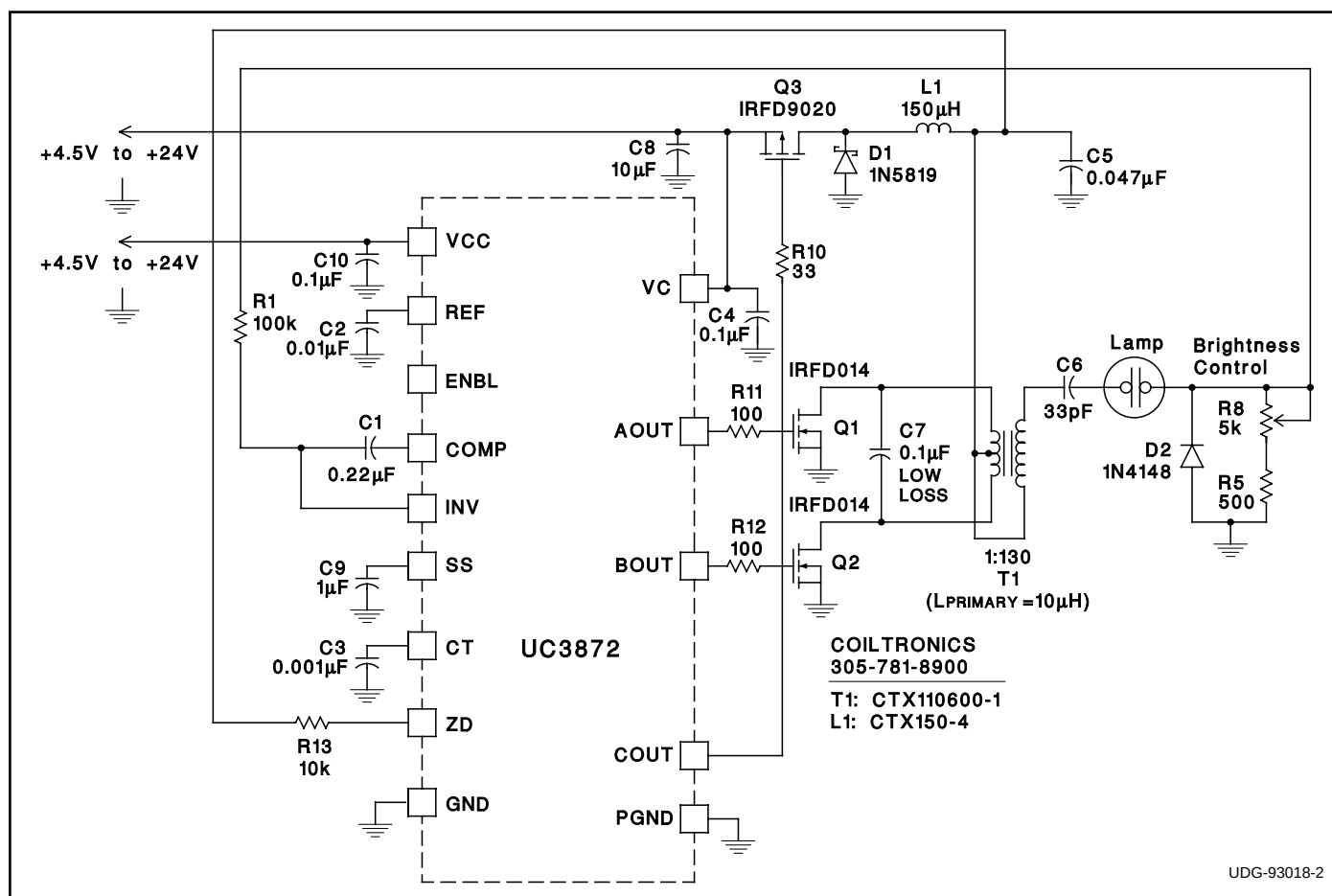


Figure 1. Typical application.

APPLICATIONS INFORMATION

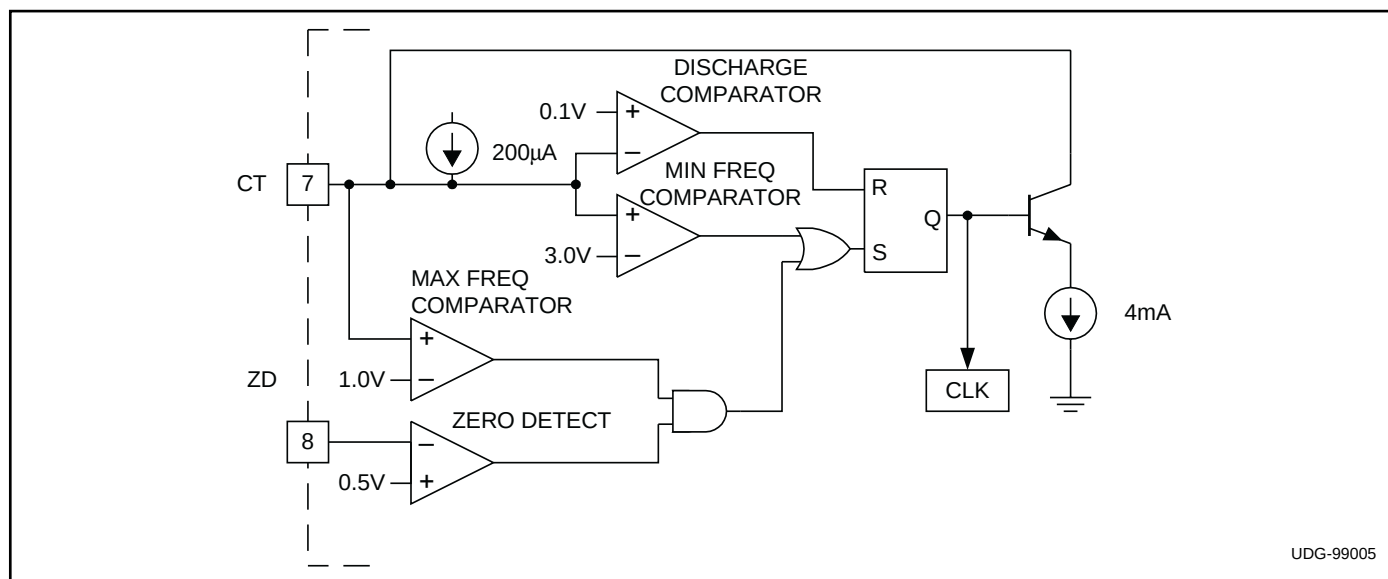


Figure 2. UC3872 oscillator section.

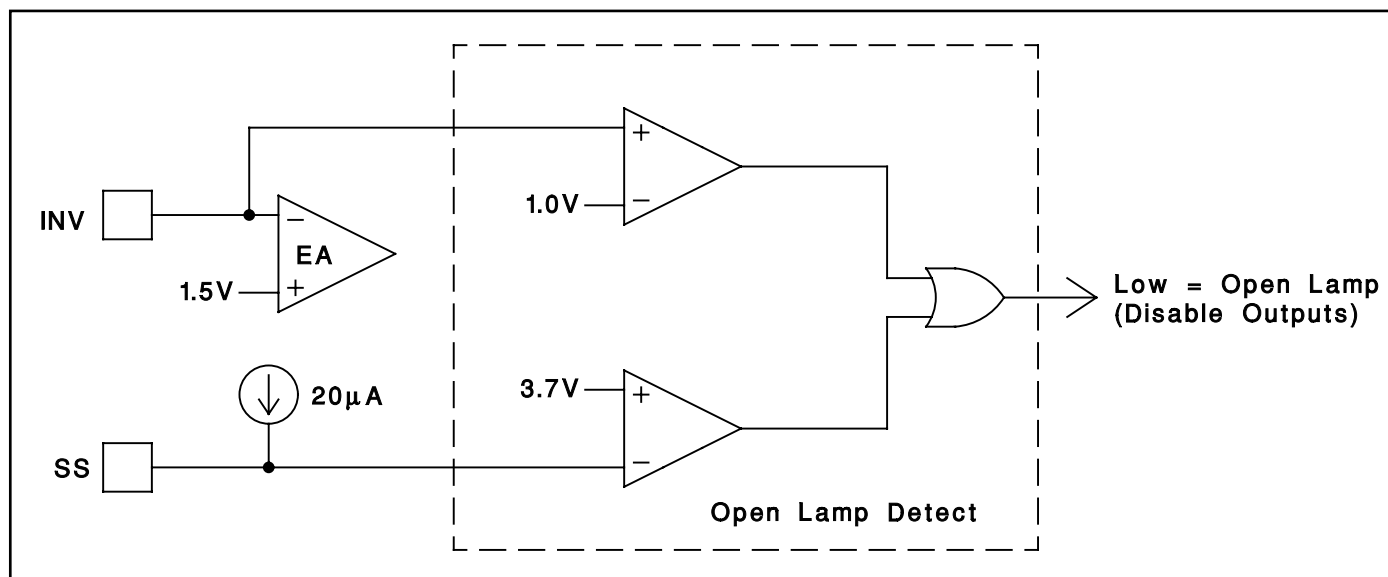


Figure 3. UC3872 open lamp detect circuitry.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
UC2872DW	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2872DWG4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2872DWTR	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2872DWTRG4	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2872N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC2872NG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC2872Q	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UC2872QG3	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UC3872DW	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872DWG4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872DWTR	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872DWTRG4	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872M	ACTIVE	SSOP/ QSOP	DBQ	16	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872MG4	ACTIVE	SSOP/ QSOP	DBQ	16	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872MTR	ACTIVE	SSOP/ QSOP	DBQ	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872MTRG4	ACTIVE	SSOP/ QSOP	DBQ	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3872N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC3872NG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and

package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

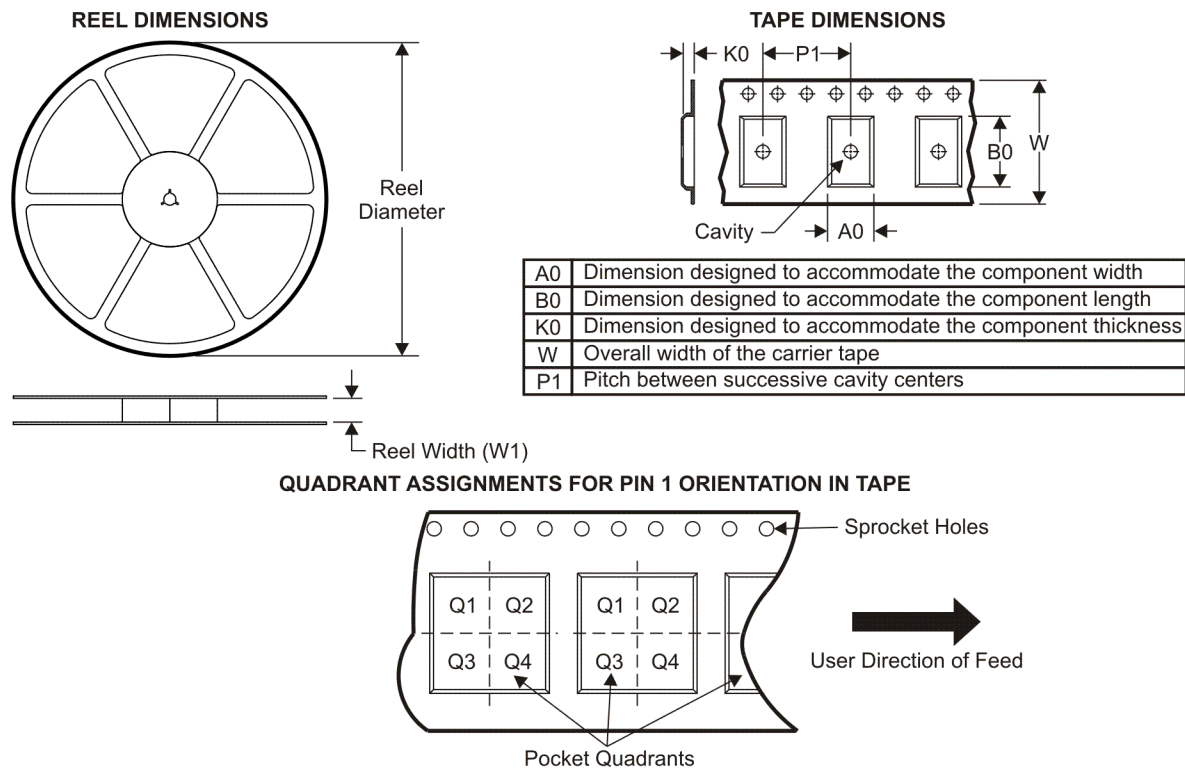
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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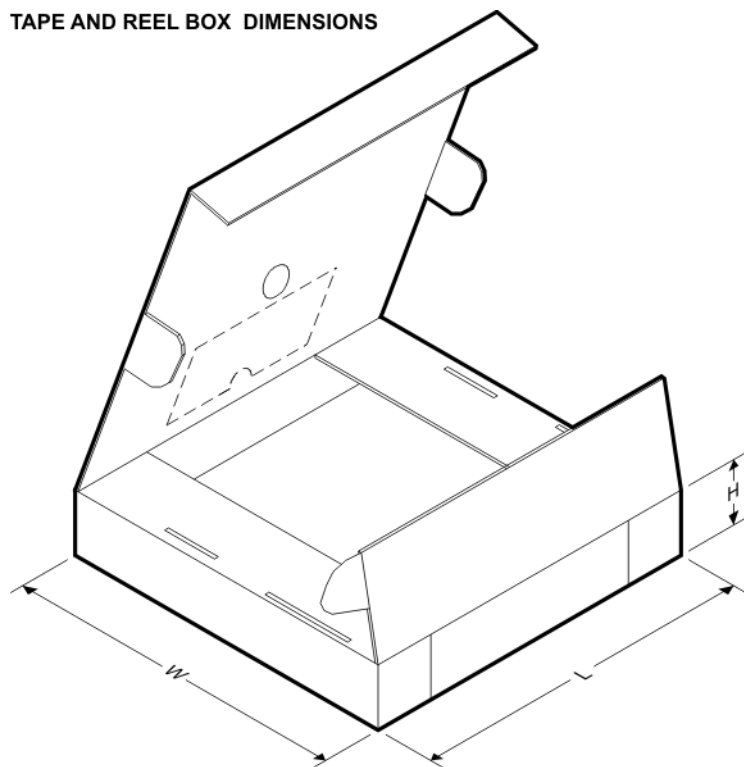
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2872DWTR	SOIC	DW	16	2000	330.0	16.4	10.85	10.8	2.7	12.0	16.0	Q1
UC3872DWTR	SOIC	DW	16	2000	330.0	16.4	10.85	10.8	2.7	12.0	16.0	Q1
UC3872MTR	SSOP/ QSOP	DBQ	16	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC2872DWTR	SOIC	DW	16	2000	346.0	346.0	33.0
UC3872DWTR	SOIC	DW	16	2000	346.0	346.0	33.0
UC3872MTR	SSOP/QSOP	DBQ	16	2500	346.0	346.0	29.0

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